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## FAIRCHILD

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## FQP6N60C/FQPF6N60C **600V N-Channel MOSFET**

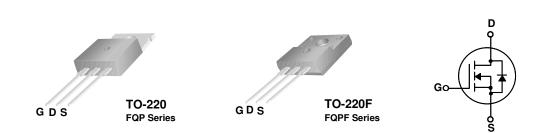
## **General Description**

These N-Channel enhancement mode power field effect transistors are produced using Fairchild's proprietary, planar stripe, DMOS technology.

This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency switched mode power supplies, active power factor correction, electronic lamp ballasts based on half bridge topology.

#### **Features**

- 5.5A, 600V,  $R_{DS(on)}$  = 2.0 $\Omega$  @V<sub>GS</sub> = 10 V Low gate charge ( typical 16 nC)
- Low Crss (typical 7 pF) •
- Fast switching
- 100% avalanche tested
- · Improved dv/dt capability



## Absolute Maximum Ratings T<sub>C</sub> = 25°C unless otherwise noted

Symbol	Parameter		FQP6N60C	FQPF6N60C	Units
V <sub>DSS</sub>	Drain-Source Voltage		600		V
I <sub>D</sub>	Drain Current - Continuous ( $T_C = 25^{\circ}C$ )		5.5	5.5 *	А
	- Continuous (T <sub>C</sub> = 100°C)	1	3.3	3.3 *	А
I <sub>DM</sub>	Drain Current - Pulsed	(Note 1)	22	22 *	А
V <sub>GSS</sub>	Gate-Source Voltage		±	30	V
E <sub>AS</sub>	Single Pulsed Avalanche Energy	(Note 2)	300		mJ
I <sub>AR</sub>	Avalanche Current	(Note 1)	5.5		А
E <sub>AR</sub>	Repetitive Avalanche Energy (Note 1)		12.5		mJ
dv/dt	Peak Diode Recovery dv/dt (Note 3)		4.5		V/ns
P <sub>D</sub>	Power Dissipation (T <sub>C</sub> = 25°C)		125	40	W
	- Derate above 25°C		1.0	0.31	W/°C
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature Range		-55 to +150		°C
т	Maximum lead temperature for soldering purposes,		300		°C
Τ <sub>L</sub>	1/8" from case for 5 seconds				

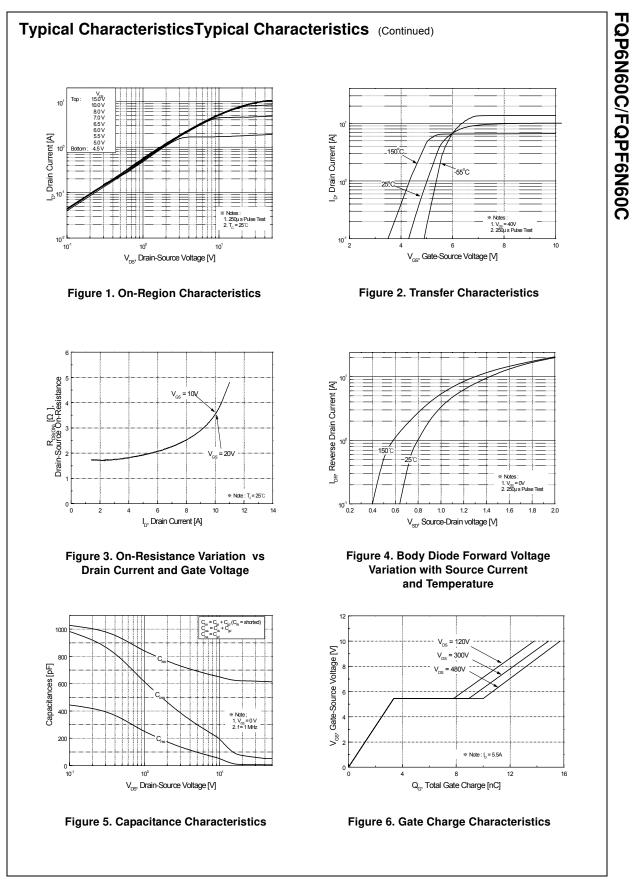
## **Thermal Characteristics**

Symbol	Parameter	FQP6N60C	FQPF6N60C	Units
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case	1.0	3.2	°C/W
$R_{\theta CS}$	Thermal Resistance, Case-to-Sink Typ.	0.5		°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	62.5	62.5	°C/W

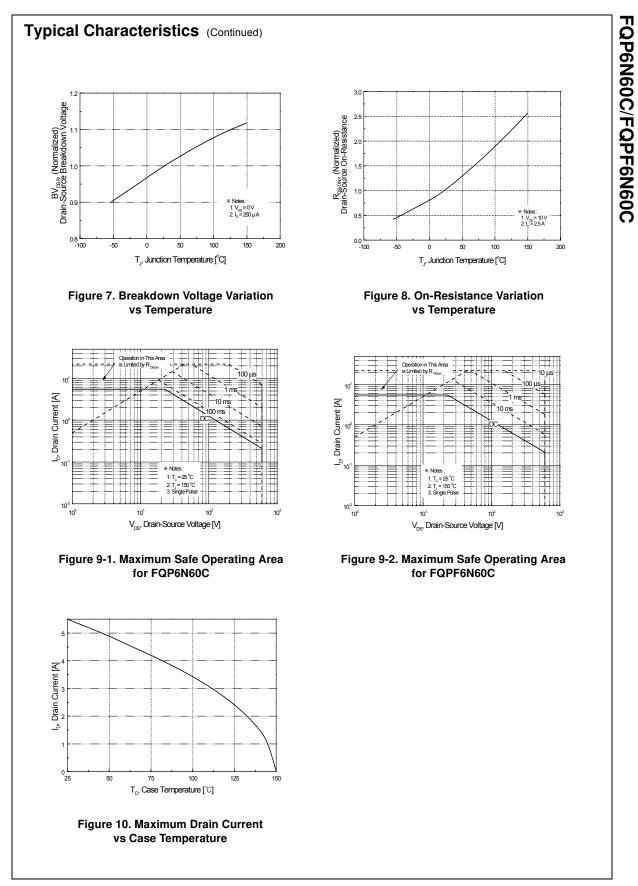
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QFET®

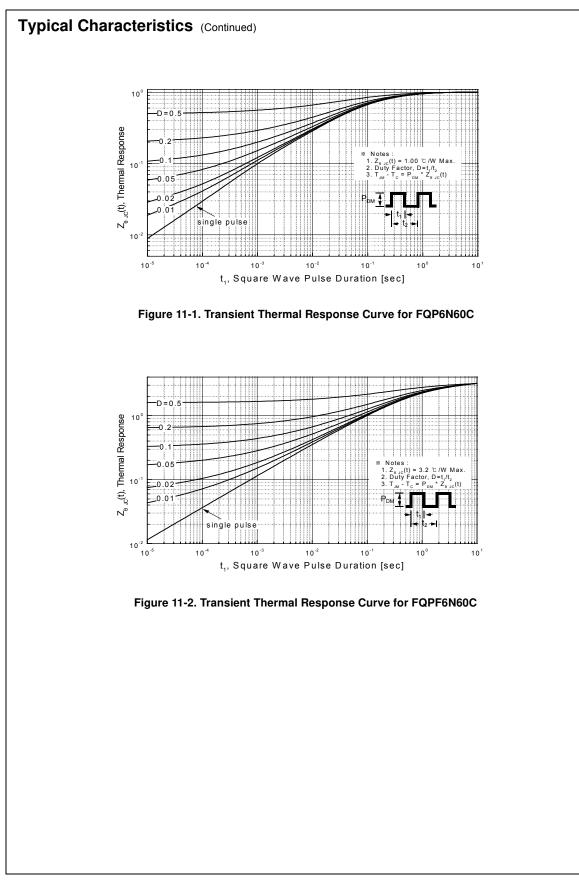
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GSSR   Gate-Body Leakage Current, Reverse $V_{GS} = -30 \text{ V}, V_{DS} = 0 \text{ V}$ 0   nA     On Characteristics   On-Resistance   V_{GS} = 10 V, I_D = 2.75 A    1.7   2.0 $\Omega$ Op-Resistance   V_{DS} = 40 V, I_D = 2.75 A    4.8    S     Opmanic Characteristics   V_DS = 40 V, I_D = 2.75 A   (Note 4)    4.8    S     Opmanic Characteristics   V_DS = 40 V, I_D = 2.75 A   (Note 4)    4.8    S     Output Capacitance   V_DS = 25 V, V_{GS} = 0 V, f = 1.0 MHz    620   810 pF   pF     Switching Characteristics   Matrian   10 pF   P    65   85 <t< td=""></t<>
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Dynamic Characteristics $C_{iss}$ Input Capacitance $V_{DS} = 25 \text{ V}, V_{GS} = 0 \text{ V},$ $620$ $810$ $pF$ $C_{oss}$ Output Capacitance $f = 1.0 \text{ MHz}$ $655$ $85$ $pF$ $C_{rss}$ Reverse Transfer Capacitance $r = 1.0 \text{ MHz}$ $7$ $10$ $pF$ Switching Characteristics $d(on)$ Turn-On Delay Time $V_{DD} = 300 \text{ V}, I_D = 5.5\text{ A},$ $15$ $40$ $ns$ $r$ Turn-On Rise Time $R_G = 25 \Omega$ $455$ $100$ $ns$ $r_i$ Turn-Off Delay Time $(Note 4, 5)$ $455$ $100$ $ns$ $r_i$ Turn-Off Fall Time $V_{DS} = 480 \text{ V}, I_D = 5.5\text{ A},$ $16$ $20$ $nC$ $Q_{gs}$ Gate-Source Charge $V_{GS} = 10 \text{ V}$ $6.5$ $nC$ $Q_{gd}$ Gate-Drain Charge $V_{GS} = 10 \text{ V}$ $6.5$ $nC$ $Drain-Source$ Diode Characteristics and Maximum Ratings $$ $5.5$ $A$ $S_{SD}$ Maximum Pulsed Drain-Source Diode Forward Current $$ $22$ $A$ $V_{SD}$ Drain-Source Diode Forward Voltage $V_{GS} = 0 \text{ V}, I_S = 5.5 \text{ A}$ $$ $1.4$ $V$
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$V_{SD}$ Drain-Source Diode Forward Voltage $V_{GS} = 0 V, I_S = 5.5 A$ 1.4 V
$r_{\rm rr}$ Reverse Recovery Time V <sub>GS</sub> = 0 V, I <sub>S</sub> = 5.5 A, 310 ns
$Q_{rr}$ Reverse Recovery Charge $dI_F / dt = 100 \text{ A/}\mu\text{s}$ (Note 4) 2.1 $\mu\text{C}$
$V_{SD}$ Drain-Source Diode Forward Voltage $V_{GS} = 0 V$ , $I_S = 5.5 A$ 1.4V



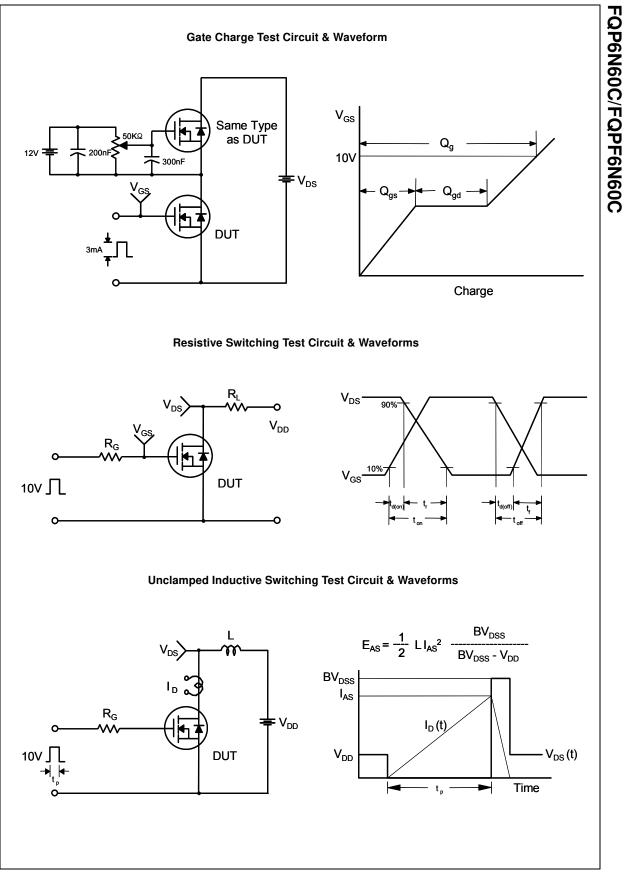
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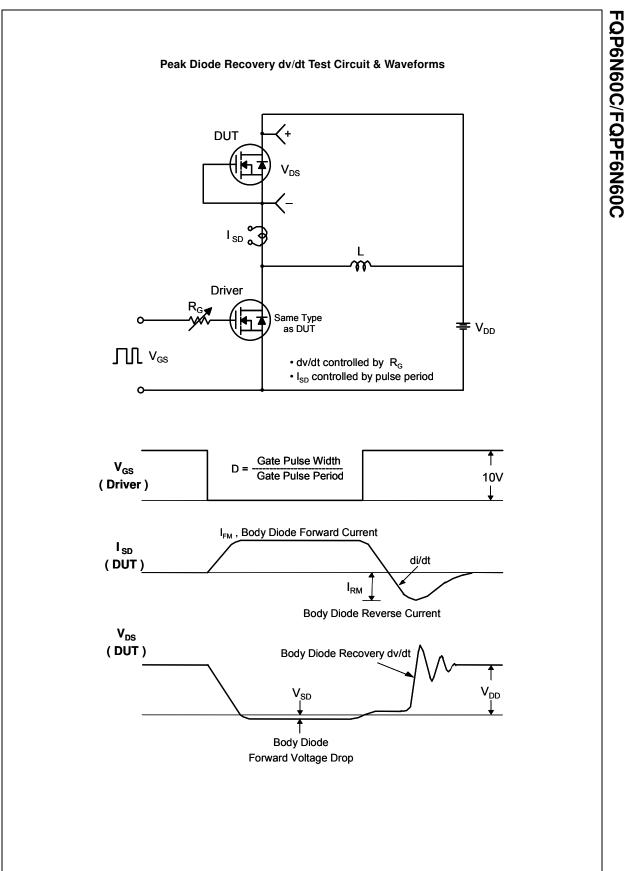


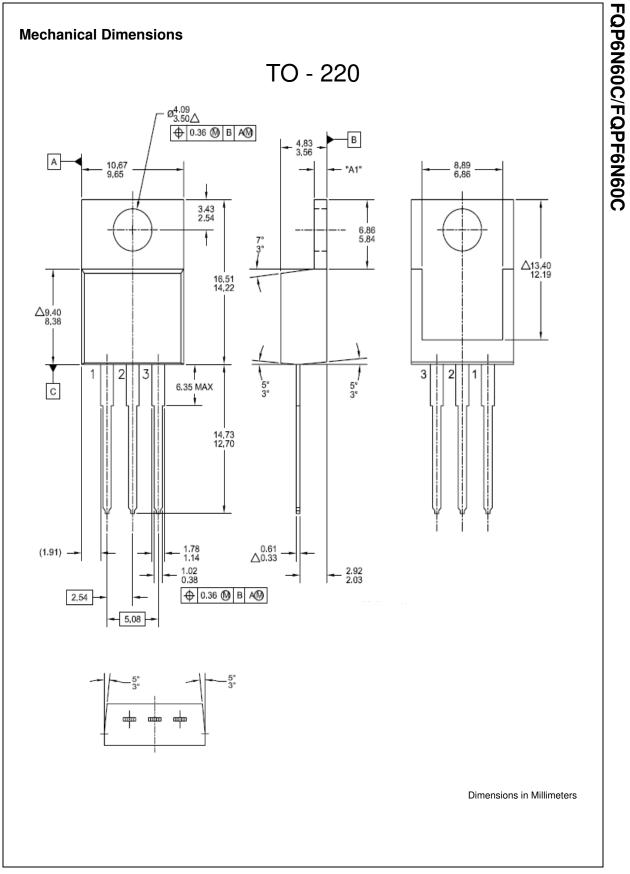
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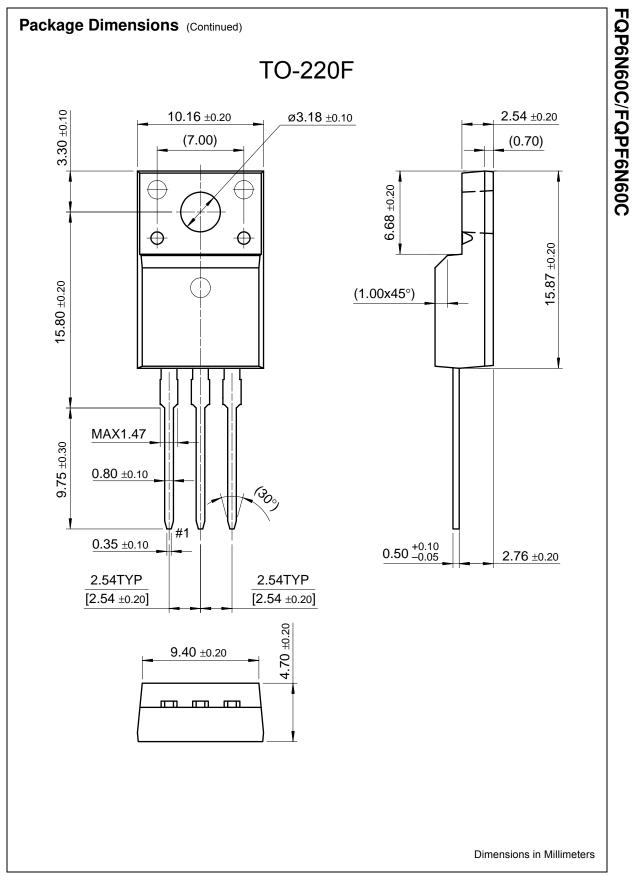


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